



# 60V DUAL N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

### **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> Tc = +25°C	
60V	12.5mΩ @ V <sub>GS</sub> = 10V	44A	
607	16.8mΩ @ V <sub>GS</sub> = 4.5V	38A	

#### **Features**

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

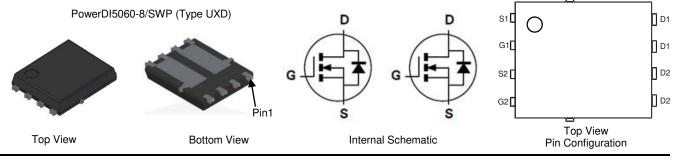
### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- Wireless Charging
- DC-DC Converters
- Power Management

### **Mechanical Data**

- Case: PowerDI<sup>®</sup>5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



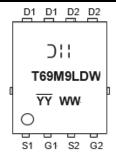
#### **Ordering Information** (Note 4)

Part Number	Case	Packaging	
DMT69M9LPDW-13	PowerDI5060-8/SWP (Type UXD)	2500/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

#### **Marking Information**



Dill= Manufacturer's Marking
T69M9LDW = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 21 = 2021)
WW = Week Code (01 to 53)

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# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V <sub>DSS</sub>	60	V
Gate-Source Voltage			$V_{GSS}$	±16	V
Continuous Drain Current Vos = 10V (Note 6)		T <sub>C</sub> = +25°C T <sub>C</sub> = +70°C	l <sub>D</sub>	44.0 35.5	Α
		$T_A = +25^{\circ}C$		11.0	
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 5)	Steady State	$T_A = +70^{\circ}C$	I <sub>D</sub>	8.8	Α
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	176	Α
Maximum Continuous Body Diode Forward Current (Note 6)			ls	44	Α
Pulsed Body Diode Forward Current (10μs Pulse, Duty Cycle = 1%)			Ism	176	Α
Avalanche Current, L = 0.1mH			las	30	Α
Avalanche Energy, L = 0.1mH			Eas	45	mJ

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	$P_{D}$	2.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	50	°C/W
Total Power Dissipation (Note 6) $T_C = +25^{\circ}C$		PD	40.3	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	3.1	°C/W	
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C	

### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 48V$ , $V_{GS} = 0V$	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 16V$ , $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.7	_	2	٧	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	9.9	12.5	mΩ	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	
Static Drain-Source On-nesistance	R <sub>DS(ON)</sub>	_	11.9	16.8	11177	$V_{GS} = 4.5V, I_{D} = 15A$	
Diode Forward Voltage	$V_{SD}$	_	0.9	1.2	V	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	-	2212	_		$V_{DS} = 30V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Output Capacitance	Coss	_	495	_	pF		
Reverse Transfer Capacitance	Crss	_	46	_			
Gate Resistance	Rg	_	1.7	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	33.5	_			
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	15.6	_	nC	\/ 20\/ I- 10.54	
Gate-Source Charge	Qgs	_	4.7	_	iiC	$V_{DS} = 30V, I_{D} = 13.5A$	
Gate-Drain Charge	Qgd	_	5.3	_			
Turn-On Delay Time	td(on)	_	4.5	_			
Turn-On Rise Time	t <sub>R</sub>	_	8.6	_		$V_{GS} = 10V, V_{DD} = 30V,$ $R_{G} = 6\Omega, I_{D} = 13.5A$	
Turn-Off Delay Time	tD(OFF)	_	35.9	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	_	15.7	_			
Reverse Recovery Time	t <sub>RR</sub>	_	18.2	_	ns	1 40 50 41/44 4000/	
Reverse Recovery Charge	Qrr	_	33.1	_	nC	I <sub>F</sub> = 13.5A, di/dt = 400A/μs	

 Device mounted on FR-4 substrate PC board, 2oz. copper, with thermal bias to bottom layer 1inch square copper plate.
 Thermal resistance from junction to soldering point (on the exposed drain pad).
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing. Notes:



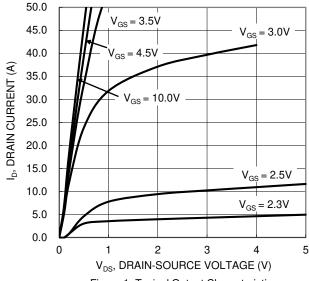


Figure 1. Typical Output Characteristic

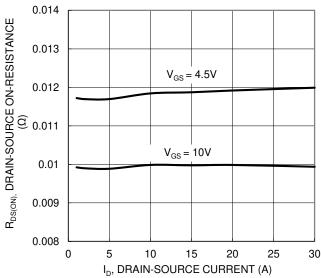


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

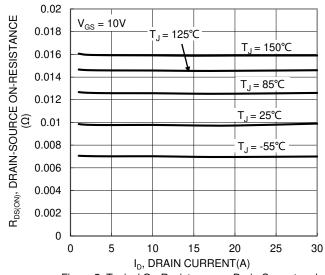


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

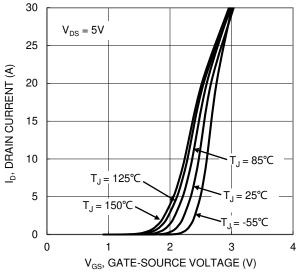


Figure 2. Typical Transfer Characteristic

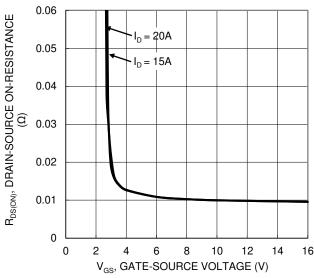


Figure 4. Typical Transfer Characteristic

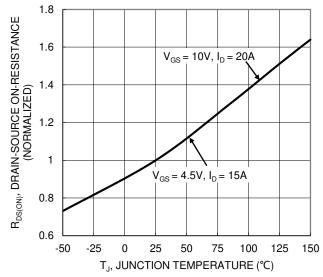


Figure 6. On-Resistance Variation with Junction Temperature



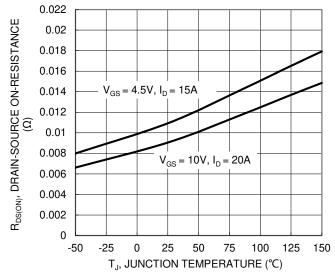


Figure 7. On-Resistance Variation with Junction Temperature

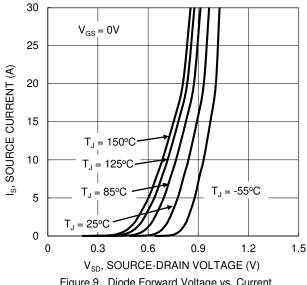


Figure 9. Diode Forward Voltage vs. Current

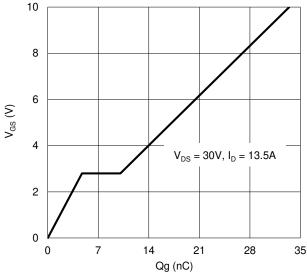


Figure 11. Gate Charge

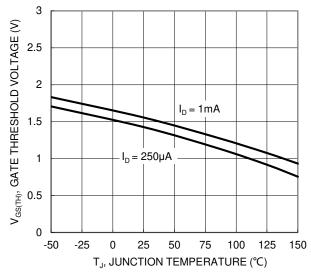
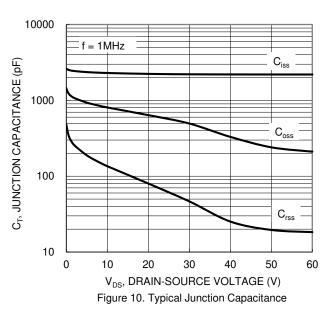


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 100 ID, DRAIN CURRENT (A) 10 10ms 1  $T_{J(Max)} = 150^{\circ}C$   $T_{C} = 25^{\circ}C$ Single Pulse DUT on Infinite 0.1 Heatsink  $V_{GS} = 10V$ 0.01 0.1 100 10 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



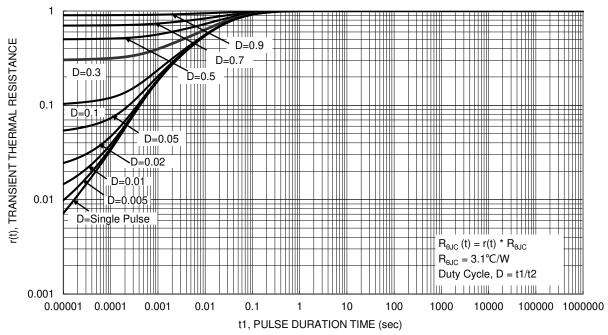
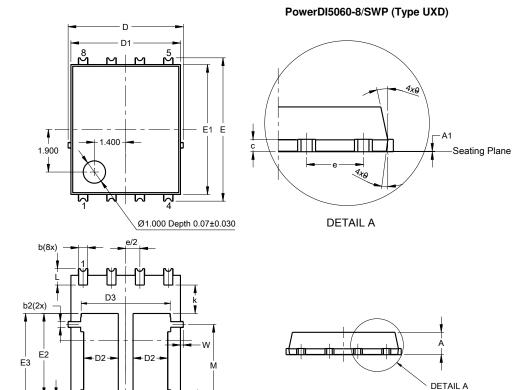


Figure 13. Transient Thermal Resistance



### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

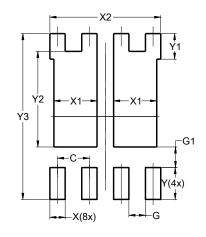


DowarDIE060 9/CWD					
PowerDI5060-8/SWP (Type UXD)					
Dim	Min Max		Тур		
Α	0.90	1.10	1.00		
<b>A</b> 1	0.00	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	(	).25REF			
С	0.230	0.330	0.277		
D	5	.15 BS0	)		
D1	4.70	5.10	4.90		
D2	1.46	1.66	1.55		
D3	3.78	4.18	3.98		
E	6	.40 BS0	)		
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1	.27BSC	)		
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
М	3.205	4.005	3.605		
W	0.025	0.225	0.125		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI5060-8/SWP (Type UXD)



Dimensions	Value (in mm)		
C	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	1.720		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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